

L Number	Hits	Search Text	DB	Time stamp
1	1	6384473.pn. and (array adj1 binary adj optic)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 09:27
2	157716	(optical\$2 near2 (device package))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 09:51
3	57865	(window near3 (glass transparent))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 09:55
4	2727	((optical\$2 near2 (device package))) and (window near3 (glass transparent))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 09:55
5	2727	((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 09:59
6	682171	(substrate carrier body base) with (opening recess apperture (through adj hole))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:06
7	451	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:11
8	213	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and (polymer ceramic)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:13
9	154	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and (polymer ceramic) and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:14
10	53	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and (polymer ceramic) and glass and (bump ball flipchip (flip adj chip))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:14
11	281	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:14
12	70	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and glass and (bump ball flipchip (flip adj chip))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:15

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3	57865	(window near3 (glass transparent))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:29
4	2727	((optical\$2 near2 (device package))) and (window near3 (glass transparent))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 09:55
5	2727	((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 09:59
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7	451	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:11
8	213	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and (polymer ceramic)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:13
9	154	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and (polymer ceramic) and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:14
10	53	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and (polymer ceramic) and glass) and (bump ball flipchip (flip adj chip))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:30
11	281	((optical\$2 near2 (device package))) and ((window near3 (glass transparent))) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:14

13	102	(US-5689091-\$ or US-5633530-\$ or US-5444296-\$ or US-6440770-\$ or US-6043559-\$ or US-6324067-\$ or US-5963429-\$ or US-6380631-\$ or US-5043794-\$ or US-5600541-\$ or US-5497031-\$ or US-5357056-\$ or US-4187868-\$ or US-5327325-\$ or US-6420782-\$ or US-4630172-\$ or US-5012386-\$ or US-5672909-\$ or US-6416238-\$ or US-6388264-\$ or US-6349105-\$ or US-6117193-\$ or US-6153829-\$ or US-5787575-\$ or US-5814883-\$ or US-5491362-\$).did. or (US-5173767-\$ or US-6396116-\$ or US-6342670-\$ or US-6440778-\$ or US-6214644-\$ or US-6294839-\$ or US-6404648-\$ or US-6445591-\$ or US-6184463-\$ or US-4513355-\$ or US-5611876-\$ or US-5461196-\$ or US-6359234-\$ or US-6323065-\$ or US-5751063-\$ or US-5796170-\$ or US-5583378-\$ or US-4879588-\$ or US-5831810-\$ or US-5923540-\$ or US-6387507-\$ or US-6268231-\$ or US-6117367-\$ or US-6011294-\$ or US-5744232-\$ or US-5768109-\$ or US-5686790-\$).did. or (US-5945041-\$ or US-5937598-\$ or US-5820781-\$ or US-6215928-\$ or US-6361281-\$ or US-6331992-\$ or US-RE35069-\$ or US-5216805-\$ or US-5149958-\$ or US-6266197-\$ or US-6492699-\$ or US-6396043-\$ or US-6262513-\$ or US-6320178-\$ or US-4814943-\$ or US-6488419-\$ or US-5128956-\$ or US-5703893-\$ or US-5960142-\$ or US-5706302-\$ or US-5737349-\$ or US-5247530-\$ or US-5381499-\$ or US-5132532-\$ or US-6220765-\$ or US-5010276-\$ or US-6417127-\$).did. or (US-6306788-\$ or US-5885916-\$ or US-6407381-\$ or US-6384473-\$ or US-6379988-\$ or US-6271056-\$ or US-6130448-\$ or US-5952714-\$ or US-5867368-\$ or US-5753857-\$ or US-5107328-\$ or US-6451624-\$).did. or (US-20010050373-\$ or US-20020113321-\$ or US-20020003819-\$ or US-20020006687-\$).did. or (JP-08236738-\$ or JP-11074395-\$ or JP-11145317-\$ or JP-09148681-\$ or JP-09148622-\$ or JP-06318647-\$).did.	USPAT; US-PGPUB; JPO	2003/02/05 10:15
12	70	(((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) and (bump ball flipchip (flip adj chip)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:21
14	211	(((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) not ((((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) and (bump ball flipchip (flip adj chip)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:22

15	51	(((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) not (((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) and (bump ball flipchip (flip adj chip)))) and package 5870638.URPN.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:25
16	6	(((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) not (((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) and (bump ball flipchip (flip adj chip)))) not	USPAT USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:23 2003/02/05 10:25
17	0	(((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) not (((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) and (bump ball flipchip (flip adj chip)))) not		
18	160	(((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) not (((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) and (bump ball flipchip (flip adj chip)))) not	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:26
19	1	(((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) not (((((optical\$2 near2 (device package))) and ((window near3 (glass transparent)))) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and glass) and (bump ball flipchip (flip adj chip)))) and package 6384473.pn. and (array adj1 binary adj optic)) and (window glass transparent)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:29
20	52157	((optical\$2 near2 (device package))) and (window glass transparent)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:29
21	4906	((optical\$2 near2 (device package))) and (window glass transparent)) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:29
22	1001	((optical\$2 near2 (device package))) and (window glass transparent)) and ((substrate carrier body base) with (opening recess apperture (through adj hole))) and (bump ball flipchip (flip adj chip))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:30

23	752	(((((optical\$2 near2 (device package))) and (window glass transparent)) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and (bump ball flipchip (flip adj chip))) and (die chip ic (optical adj (element device)) ccd)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:33
24	73	(((((optical\$2 near2 (device package))) and (window glass transparent)) and ((substrate carrier body base) with (opening recess apperture (through adj hole)))) and (bump ball flipchip (flip adj chip))) and (second near (die chip ic (optical adj (element device)) ccd))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/02/05 10:50
25	0	6396116.URPN.	USPAT	2003/02/05 10:51
26	10	("5394490"   "5811799"   "5821532"   "5861654"   "6011294"   "6059188"   "6130448"   "6147389"   "6150724"   "6303387").PN.	USPAT USPAT	2003/02/05 10:52
27	2	6147389.URPN.	USPAT	2003/02/05 10:53
28	4	("4926227"   "5122561"   "5359208"   "5867368").PN.	USPAT	2003/02/05 10:54
29	3	("5327325"   "5357056"   "5753857").PN.	USPAT	2003/02/05 10:55
30	5	6184463.URPN.	USPAT	2003/02/05 11:00
31	23	("3745505"   "3777221"   "4577214"   "4862323"   "5019673"   "5081563"   "5134246"   "5196089"   "5258575"   "5371404"   "5438224"   "5461197"   "5488542"   "5545924"   "5589781"   "5635761"   "5663593"   "5811879"   "5815372"   "5854534"   "5925934"   "5940687"   "6087732").PN.	USPAT USPAT	2003/02/05 11:01